

- Temperature cycling
- Constant acceleration
- •24, 96, 160 hour burn-in
- Three level temperature screening

Doc.# 005-0006202 Rev. E

• MIL-STD-461 (C, D, E, F)

RTCA/DO-160(E, F, G) Section 22

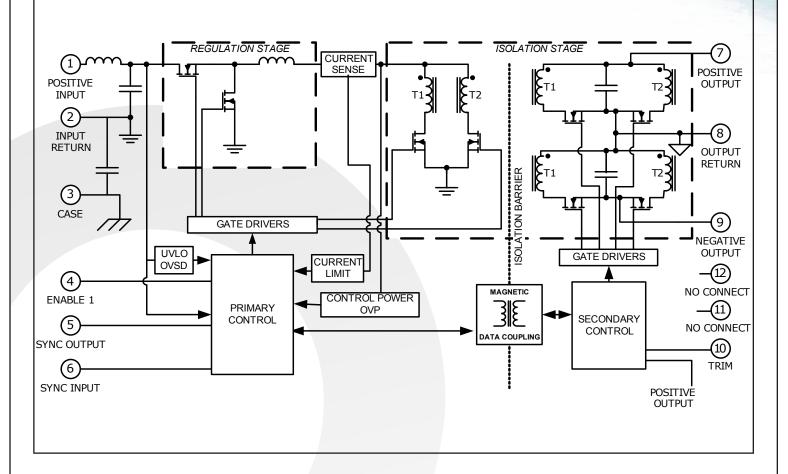
DEF-STAN 61-5 (part 6)/(5, 6) for V<sub>IN</sub> > 16V

03/31/16

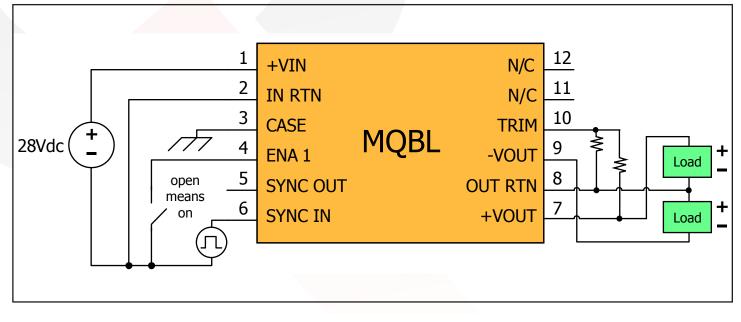


**Current: 4A Total** 

#### **BLOCK DIAGRAM**



# TYPICAL CONNECTION DIAGRAM



Page 2

Synce				E.T	MQBL-28-05 Output: ±5V Current: 4A Te	M
Technical Specif	CEI	tion		- Alb		
MQBL-28-05D ELECTRIC	CAL (	CHA	RAC1	<b>FERI</b>	STICS	and a
Parameter	Min.	Тур.	Max.	Units	Notes & Conditions	Group A
Specifications subject to change without notice					Vin = $28V dc \pm 5\%$ , +Iout = -Iout = $2A$ , CL = $0\mu$ F, free running (see Note 9) unless otherwise specified	(see Note 11)
ABSOLUTE MAXIMUM RATINGS						(
Input Voltage			60	V		
Non-Operating Operating			60	V	See Note 1	
Reverse Bias (Tcase = 125°C)			-0.8	V		
Reverse Bias (Tcase = $-55^{\circ}$ C)			-1.2	V		
Isolation Voltage (I/O to case, I to O)	500		500			
Continuous Transient (<100uc)	-500 -800		500 800	V V		
Transient (≤100µs) Operating Case Temperature	-800		125	°C	HB Grade Products, See Notes 2 & 15	
Storage Case Temperature	-65		135	°C		
Lead Temperature (20s)			300	°C		
Voltage at ENA1	-1.2		50	V		
INPUT CHARACTERISTICS Operating Input Voltage Range	16	28	40	V	Continuous	1, 2, 3
"	16	28	50	V	Transient, 1s	1, 2, 3
Input Under-Voltage Shutdown	10	20	50	·	See Note 3	
Turn-On Voltage Threshold	14.75	15.50	16.00	V		1, 2, 3
Turn-Off Voltage Threshold	14.00	14.75	15.50	V		1, 2, 3
Shutdown Voltage Hysteresis Input Over-Voltage Shutdown	0.65	0.85	1.05	V	See Note 3	
Turn-Off Voltage Threshold	52.0	55.0	58.0	V		
Turn-On Voltage Threshold	50.5	54.0	56.5	V		
Shutdown Voltage Hysteresis	1.0	2.0	3.0	V		
Input Filter Component Values (L\C) Maximum Input Current		2.2\6.4		μΗ\μF	Internal Values	
No Load Input Current (operating)		75	1.7	A mA	Vin = 16V; +Iout = -Iout = 2A	1, 2, 3
Disabled Input Current		11	17	mA		1, 2, 3
Input Terminal Current Ripple (pk-pk)		25	40	mA	Bandwidth = 100kHz – 10MHz; see Figure 20	1, 2, 3
OUTPUT CHARACTERISTICS						
Output Voltage Set Point (Tcase = 25°C) Positive Output	4.95	5.00	5.05		See Note 14	1
Negative Output	-5.05	-5.00	-4.95	V		1
Output Voltage Set Point Over Temperature	5105	5100		v	See Note 14	-
Positive Output	4.90	5.00	5.10	V		2, 3
Negative Output	-5.10	-5.00	-4.90	V		2, 3
Positive Output Voltage Line Regulation Positive Output Voltage Load Regulation	-20 -20	0	20 20	mV mV	See Note 14 See Note 14; +Vout @(+Iout=-Iout=0A) - +Vout @(+Iout=-Iout=2A)	1, 2, 3 1, 2, 3
Total Positive Output Voltage Range	4.90	5.00	5.10	V	See Note 14, + Volt @(+10011001-0A) + + Volt @(+10011001-2A)	1, 2, 3
Output Voltage Cross Regulation	75	250	500	mV	See Notes 13 and 14; -Vout@(+Iout=-Iout=0.8A)Vout@(+Iout=3.2A, -Iout=0.8A)	1, 2, 3 1, 2, 3
Output Over-Voltage Shutdown	5.6	6.1	7.1	V		See Note
Output Voltage Ripple and Noise Peak to Peak	0	20	75	mV	Bandwidth = $10$ MHz; CL= $11\mu$ F on both outputs	1, 2, 3
Operating Output Current Range	0 0		4 3.2	A	(+Iout) + (-Iout) Maximum +Iout or -Iout	1, 2, 3
Operating Output Power Range	0		20	ŵ	Total on both outputs	1, 2, 3
Output DC Current-Limit Inception	4.10	5.20	6.30	Α	See Note 4; +Iout + -Iout; +Iout = -Iout	1, 2, 3
Maximum Output Capacitance			2,000	μF	Total on both outputs	See Note
DYNAMIC CHARACTERISTICS					See Note 6	
Output Voltage Deviation Load Transient For a Pos. Step Change in Load Current	-300	-200		mV	Total Iout step = 2A to 4A, 0.4A to 2A; $CL=11\mu$ F on both outputs	4, 5, 6
For a Neg. Step Change in Load Current	500	200	300	mV		4, 5, 6
Output Voltage Deviation Line Transient					Vin step = 16V to 50V; CL=11 $\mu$ F on both outputs; see Note 7	, _, J
For a Pos. Step Change in Line Voltage	-125		125	mV		
For a Neg. Step Change in Line Voltage	-125		125	mV		
Turn-On Transient Output Voltage Rise Time		6	10	ms	+Vout = 0.5V to 4.5V; Full Resistive Load	4, 5, 6
Output Voltage Overshoot		0	2	%	Resistive load	See Note
Turn-On Delay, Rising Vin		5.5	8.0	ms	ENA = 5V; see Notes 8 & 10	4, 5, 6
Turn-On Delay, Rising ENA		3.0 100	6.0 150	ms	See Note 10 See Note 10	4, 5, 6 4, 5, 6
Restart Inhibit Time				ms	Lice Note 1()	

Doc.# 005-0006202 Rev. E

#### **MQBL-28-05D**

Output: ±5V

Same and

**Current: 4A Total** 

**Technical Specification** 

#### **MQBL-28-05D ELECTRICAL CHARACTERISTICS (Continued)** Min | Typ | Max | Units | Notes & Conditions

EFFICIENCY   Image: Constraint of the constrai	Parameter	Min.	Typ.	Max.	Units	Notes & Conditions	Group A
EFFICIENCY   Image: Constraint of the constrai	Specifications subject to change without notice					Vin = 28V dc $\pm$ 5%, +Iout = -Iout = 2A, CL = 0 $\mu$ F,	Subgroup (see Note 11)
Tout = 4 A (16 Vin)   84   88   96   Figure 2 A (16 Vin)   Figure 3 A (16 Vin)   F	EFFICIENCY					Thee running (see Note 9) unless otherwise specified	(See Note II)
Jout = 2 A (16 Vm)   83   87   %6     Iout = 4 A (28 Vin)   83   87   %6   1, 2, 3     Iout = 4 A (28 Vin)   81   86   %6   1     Iout = 4 A (20 Vin)   81   86   %6   1     Iout = 2 A (16 Vin)   80   83   %6   1     Iout = 2 A (20 Vin)   80   85   %6   1     Iout = 4 A (20 Vin)   80   85   %6   1     Iout = 2 A (16 Vin)   80   85   %6   1     Iout = 2 A (16 Vin)   80   85   %6   1     Iout = 2 A (16 Vin)   80   85   %6   1     Iout = 2 A (16 Vin)   80   85   %6   1     Iout = 1 A (10 Vin)   80   85   %6   1     Isolation Notage   100   V   1   1     Isolation Resistance (in rt to out rtn)   100   MΩ   1   1     Isolation Resistance (in runing)   500   550   600   KHz		84	88		%		
Iout = 4 A (28 Vin)   83   87   %   1, 2, 3     Iout = 2 A (28 Vin)   82   85   %   1     Iout = 2 A (30 Vin)   80   83   %   1     Iout = 2 A (30 Vin)   80   83   %   1     Iout = 4 A (50 Vin)   80   83   %   1     Iout = 4 A (50 Vin)   80   83   %   1     Iout = 4 A (50 Vin)   80   83   %   1     Iout = 4 A (50 Vin)   80   85   %   1     Isolation Voltage   1.3   W   Sustained short circuit on output   1     Isolation Resistance (in rtn to out rtn)   100   M2   1   1     Isolation Capacitance (in rtn to out rtn)   22   nF   1   1     Isolation Capacitance (in rtn to out rtn)   20   S50   600   KHz   1, 2, 3     Synchronization Input   700   KHz   1, 2, 3   1, 2, 3     Iogic Level High   2.0   5.5   V   VSYNC OUT = 0.8V   See							
Iout = 2 A (28 Vin)   82   85   %6     Iout = 4 A (40 Vin)   81   86   %6     Iout = 4 A (50 Vin)   80   83   %6     Iout = 4 A (50 Vin)   80   85   %6     Iout = 4 A (50 Vin)   80   85   %6     Isolation Voltage   1.3   W   Sustained short circuit on output     Isolation Voltage   1   1   1     Input RTN to Output RTN   500   V   V     Any Output Pin to Case   500   V   1     Isolation Resistance (any pin to case)   100   MQ   1     Isolation Resistance (any pin to case)   100   MQ   1     Isolation Resistance (any pin to case)   100   MQ   1     Isolation Resistance (any pin to case)   100   MQ   1     Isolation Resistance (any pin to case)   100   MQ   1     Isolation Resistance (any pin to case)   100   MQ   1, 2, 3     Logic Level High   2.0   5.5   V   1, 2, 3							1, 2, 3
Iout = 4 A (40 Vin)   81   86   %   Model		82	85		%		, ,
Jout = 2 A (40 Vin)   80   83   %     Jout = 4 A (50 Vin)   80   85   %     Load Fault Power Dissipation   1.3   W   Sustained short circuit on output     ISOLATION CHARACTERISTICS   ISOLATION CHARACTERISTICS   ISOLATION CHARACTERISTICS     Isolation Voltage   V   Dielectric strength   1     Isolation Voltage   V   1   1     Any Output Pin to Case   500   V   1     Isolation Resistance (any pin to case)   100   MQ   1     Isolation Resistance (any pin to case)   100   MQ   1     Isolation Resistance (in rth to out rth)   22   nF   1     Synchronization Input   700   kHz   1   1     Frequency Range   500   50   600   kHz   1   2, 3     Logic Level Low   -0.5   0.8   V   1, 2, 3   2, 2, 3     Logic Level High   2.0   80   %   See Note   1, 2, 3     OthrState Voltage   0   60   %		81	86		%		
Iout = 4 A (50 Vin)8085%Load Fault Power Dissipation1.3WSustained short circuit on outputIsolation Voltage1VDielectric strengthInput RTN to Output RTN500V1Any Uotput Pin to Case500V1Isolation Resistance (in rth to out rth)100MQ1Isolation Resistance (in rth to out rth)22nF1Isolation Resistance (in rth to out rth)20550600kHzSynchronization Input500550600kHz1, 2, 3Logic Level High2.05.5V1, 2, 3Logic Level High2.080%%Synchronization Output700KHz1, 2, 3Duty Cycle2080%%Synchronization Output700KHz1, 2, 3Module Of Pulldown Current2080%%Orf-State Voltage4060%%Orf-State Voltage2.24.04.8YModule Of Pulldown Current804.8YOutput Voltage Tim Range1.01.0%Calculated MTBF (MIL:STD-217F2)7.27.27.4.8GB @ Tase = 70°C2.9410° Hrs.1.0° Hrs.WEIGHT		80	83		%		
Load Fault Power Dissipation 1.3 W Sustained short circuit on output   ISOLATION CHARACTERISTICS Dielectric strength 1   Isolation Voltage Dielectric strength 1   Input RTN to Output RTN 500 V 1   Any Output Pin to Case 500 V 1   Isolation Resistance (in rtn to out rtn) 100 MQ 1   Isolation Capacitance (in rtn to out rtn) 22 nF 1   Isolation Resistance (any pin to case) 100 MQ 1   Switching Frequency (free running) 500 550 600 KHz 1, 2, 3   Logic Level High 2.0 5.5 V 1, 2, 3 1, 2, 3   Logic Level High 2.0 5.5 V 1, 2, 3 2, 2, 3   Duty Cycle 20 80 % 26 26 26 26   Synchronization Output - - - - 55 V 20 20 80 %   Duty Cycle 20 0.8 V - - 1, 2, 3 - -		80	85		%		
ISOLATION CHARACTERISTICSIsolation VoltageIsolation VoltageIsolation VoltageInput RTN to Output RTN500VIAny Unput Pin to Case500V1Isolation Resistance (in rth to out rth)100MΩ1Isolation Resistance (in rth to out rth)100MΩ1Isolation Resistance (in rth to out rth)100MΩ1Isolation Resistance (in rth to out rth)22nF1Isolation Resistance (in rth to out rth)22nF1Synchronization Input500550600kHzFrequency Range500700kHz1, 2, 3Logic Level High2.05.5V1, 2, 3Logic Level Low-0.50.8V1, 2, 3Duty Cycle2080%See NoteSynchronization Output60%VVPull Down Current200.8VOff-State Voltage2.20.8VModule Off Pulldown Current80VPull-Up Voltage3.24.04.8Output Voltage Tim Range-1010%See Figure ASee Note1, 2, 3Colculated MTBF (MIL-STD-21/F2)254010 <sup>3</sup> Hrs.GB @ Tase = 70°C254010 <sup>3</sup> Hrs.WEIGHT CHARACTERISTICS10 <sup>3</sup> Hrs.10 <sup>3</sup> Hrs.WEIGHT CHARACTERISTICS10 <sup>3</sup> Hrs.10 <sup>3</sup> Hrs.			1.3		W	Sustained short circuit on output	
Input RTN to Output RTN500VVAny Unput Pin to Case500V1Isolation Resistance (in rtn to out rtn)100MQ1Isolation Resistance (any pin to case)100MQ1Isolation Resistance (any pin to case)10022nFSwitching Frequency (free running)500550600kHzSynchronization Input-550700kHzFrequency Range500-700kHzLogic Level High2.05.5V1, 2, 3Duty Cycle2080%1, 2, 3Duty Cycle2080%See NoteSynchronization Output-060%Pull Down Current20080%Orf-State Voltage200.8VModule Off Pulidown Current8004.8VOn-State Voltage3.24.04.8VPull Down Current10%See Figure A1, 2, 3Output Voltage Tim Range-1010%See Figure E1, 2, 3Calculated MTBF (MIL-STD-217F2)19210 <sup>3</sup> Hrs.10 <sup>3</sup> Hrs.10 <sup>3</sup> Hrs.GB @ Tase = 70°C254010 <sup>3</sup> Hrs.10 <sup>3</sup> Hrs.10 <sup>3</sup> Hrs.WEIGHT CHARACTERISTICSIsoIsoIsoIsoWEIGHT CHARACTERISTICSIsoIsoIsoIsoIsoIsoIsoIsoIsoIsoIsoIsoIso							
Any Input Pin to Case500VVAny Output Pin to Case500VVIsolation Resistance (in rtn to out rtn)100MQIsolation Resistance (in rtn to out rtn)100MQIsolation Resistance (in rtn to out rtn)22nFIsolation Capacitance (in rtn to out rtn)22nFFEATURE CHARACTERISTICS1Switching Frequency (free running)500550Synchronization Input500550Frequency Range500700Logic Level High2.05.5V1, 2, 3Logic Level High2.080Synchronization Unput-Pull Down Current20MAVy Cycle4060Synchronization (IRNA)-Off-State Voltage2-On-State Voltage3.24.0Andule Off Pulldown Current80On-State Voltage3.24.0Andule Off Pulldown Current10905ee Figure AOutput Voltage Tim Range-1010%See Figure AOutput Voltage Tim Range-1010%See Figure ACalculated MTBF (MIL-STD-217F2)2540Gi @ Tase = 70°C2540Alf @ Tase = 70°C2540Alf @ Tase = 70°C2540Io <sup>3</sup> HrsWEIGHT CHARACTERISTICS-Weight C CHARACTERISTICS-Weight C CHARACTERISTICS-Isolate On T	Isolation Voltage					Dielectric strength	
Any Output Pin to Case500VV1Isolation Resistance (in rth to out rth)100MQ1Isolation Capacitance (in rth to out rth)22nF1Isolation Capacitance (in rth to out rth)22nF1FEATURE CHARACTERISTICS $MQ$ 1Switching Frequency (free running)500550600kHzSynchronization Input500550600kHz1, 2, 3Logic Level High2.05.5V1, 2, 3Logic Level Low-0.50.8V20See NoteSynchronization Output2060%See NoteSee NoteSynchronization Output060%VSYNC OUT = 0.8VSee NoteOutput Cycle200.8VUpt connected to SYNC IN of other MQBL unitSee NoteOrf-State Voltage20.8VInax draw from pin allowed with module still onSee NoteOrf-State Voltage3.24.04.8VSee Figure A1, 2, 3Module On Pin Leakage Current2010%See Figure A1, 2, 3Output Voltage Trim Range3.24.04.8VSee Figure A1, 2, 3Output Voltage Trim Range3.24.04.8VSee Figure A1, 2, 3RELTABULTY CHARACTERISTICS103Hrs.103Hrs.1, 2, 3WEIGHT CHARACTERISTICS192103Hrs.103Hrs.WEIGHT CHARACTERISTICS <t< td=""><td>Input RTN to Output RTN</td><td>500</td><td></td><td></td><td>V</td><td></td><td>1</td></t<>	Input RTN to Output RTN	500			V		1
Isolation Resistance (in rtn to out rtn)   100   MΩ   MΩ   1     Isolation Resistance (any pin to case)   100   22   nF   1     Isolation Capacitance (in rtn to out rtn)   22   nF   1     Switching Frequency (free running)   500   550   600   kHz   1     Synchronization Input   500   550   600   kHz   1, 2, 3     Logic Level High   2.0   5.5   V   1, 2, 3     Logic Level Hogh   2.0   5.5   V   1, 2, 3     Duty Cycle   20   80   %   5ee Note     Synchronization Output   0   60   %   0utput connected to SYNC IN of other MQBL unit     Pull Down Current   20   0.8   V   1, 2, 3     Off-State Voltage   0   60   %   Output connected to SYNC IN of other MQBL unit   See Note     On-State Voltage   2   V   V   Imax draw from pin allowed with module still on   See Note     Output Voltage Tim Range   3.2   4.0   4.8	Any Input Pin to Case	500			V		1
Isolation Resistance (any pin to case)10022MΩMΩ1Isolation Capacitance (in rtn to out rtn)22nF1FEATURE CHARACTERISTICS500550600kHz1, 2, 3Synchronization Input500550600kHz1, 2, 3Frequency Range500700kHz1, 2, 3Logic Level High2.05.5V1, 2, 3Duty Cycle2080%%Synchronization Output-0.50.8VPull Down Current2080%Duty Cycle4060%Off-State Voltage0.8VOn-State Voltage0.8VOn-State Voltage2.00.8VOutput Voltage2.00.8VOutput Voltage3.24.04.8VCurrent drain required to ensure module is offSee NoteOutput Voltage3.24.04.8VSee Figure A0utput Voltage Trim Range-1010Output Voltage Trim Range-1010%RELIABILITY CHARACTERISTICS254010 <sup>3</sup> Hrs.GB @ Tacse = 70°C254010 <sup>3</sup> Hrs.WEIGHT CHARACTERISTICS10 <sup>3</sup> Hrs.WEIGHT CHARACTERISTICS10 <sup>3</sup> Hrs.	Any Output Pin to Case	500			V		1
Isolation Capacitance (in rtn to out rtn)   22   nF   1     FFATURE CHARACTERISTICS   1   1   1     Switching Frequency (free running)   500   550   600   kHz   1, 2, 3     Synchronization Input   500   500   700   kHz   1, 2, 3     Logic Level High   2.0   5.5   V   1, 2, 3     Logic Level Low   -0.5   0.8   V   1, 2, 3     Duty Cycle   20   80   %   See Note     Synchronization Output   -0.5   0.8   V   See Note     Pull Down Current   20   80   %   See Note     Duty Cycle   40   60   %   Output connected to SYNC IN of other MQBL unit   See Note     Off-State Voltage   0.8   V   Imax draw from pin allowed with module stifl on   See Note     On-State Voltage   3.2   4.0   4.8   V   See Figure A     Output Voltage Tim Range   -10   10   %   See Figure A   See Figure E   1, 2, 3	Isolation Resistance (in rtn to out rtn)	100			MΩ		1
FEATURE CHARACTERISTICS   Source	Isolation Resistance (any pin to case)	100			MΩ		1
Switching Frequency (free running)   500   550   600   kHz   1, 2, 3     Synchronization Input   500   700   kHz   1, 2, 3     Frequency Range   500   5.5   V   1, 2, 3     Logic Level High   2.0   5.5   V   1, 2, 3     Logic Level Low   -0.5   0.8   V   1, 2, 3     Duty Cycle   20   80   %   see Note     Synchronization Output   -0.5   80   %   see Note     Pull Down Current   20   40   60   mA   VSYNC OUT = 0.8V   See Note     Duty Cycle   40   60   mA   VSYNC OUT = 0.8V   See Note     Off-State Voltage   40   60   mA   VSYNC OUT = 0.8V   See Note     Orff-State Voltage   2   60   MA   V   Variation required to synce module is off   See Note     On-State Voltage   2   V   Module Off Pulldown Current   80   V   See Figure A   See Note     Pull-Up Voltage <td>Isolation Capacitance (in rtn to out rtn)</td> <td></td> <td>22</td> <td></td> <td>nF</td> <td></td> <td>1</td>	Isolation Capacitance (in rtn to out rtn)		22		nF		1
Synchronization Input   No   No   No     Frequency Range   500   700   KHz   1, 2, 3     Logic Level High   2.0   5.5   V   1, 2, 3     Logic Level Low   -0.5   0.8   V   1, 2, 3     Duty Cycle   20   80   %   See Note     Synchronization Output   -   -   mA   VSYNC OUT = 0.8V   See Note     Synchronization Output   -   -   mA   VSYNC OUT = 0.8V   See Note     Duty Cycle   40   60   %   Output connected to SYNC IN of other MQBL unit   See Note     Frequency Range   -   0.8   V   -   -   -     Off-State Voltage   -   0.8   V   -	FEATURE CHARACTERISTICS						
Frequency Range500700kHz1, 2, 3Logic Level High2.05.5V1, 2, 3Logic Level Low-0.50.8V1, 2, 3Duty Cycle2080%See NoteSynchronization OutputmAVSYNC OUT = 0.8VSee NotePull Down Current2060%Output connected to SYNC IN of other MQBL unitSee NoteDuty Cycle4060%Output connected to SYNC IN of other MQBL unitSee NoteEnable Control (ENA)Off-State Voltage2-VOn-State Voltage2-VModule Off Pulldown Current80-VPull-Up Voltage3.24.04.8VSee Figure A-Output Voltage Trim Range-1010%See Figure A-Output Voltage Trim Range-1010GB @ Tcase = 70°C254010 <sup>3</sup> HrsAIF @ Tcase = 70°C19210 <sup>3</sup> HrsWEIGHT CHARACTERISTICSWEIGHT CHARACTERISTICSWEIGHT CHARACTERISTICSWEIGHT CHARACTERISTICSWeight CharacteristicsWeigh	Switching Frequency (free running)	500	550	600	kHz		1, 2, 3
Logic Level High2.05.5V1, 2, 3Logic Level Low-0.50.8V1, 2, 3Duty Cycle2080%See NoteSynchronization OutputPull Down Current20MAMAVSYNC OUT = 0.8VSee NoteDuty Cycle4060%Output connected to SYNC IN of other MQBL unitSee NoteEnable Control (ENA)Off-State Voltage0.8VOn-State Voltage2-VV-On-State Voltage3.24.04.8VSee Figure AOutput Voltage Trim Range-1010%See Figure A-Calculated MTBF (MIL-STD-217F2)54010 <sup>3</sup> HrsGB @ Tcase = 70°C19210 <sup>3</sup> HrsWEIGHT CHARACTERISTICS10 <sup>3</sup> HrsWEIGHT CHARACTERISTICSWEIGHT CHARACTERISTICSWEIGHT CHARACTERISTICSWEIGHT CHARACTERISTICSWEIGHT CHARACTERISTICSWEIGHT CHARACTERISTICSWEIGHT CHARACTERISTICS <td< td=""><td></td><td></td><td></td><td></td><td></td><td></td><td></td></td<>							
Logic Level Low-0.50.8V1, 2, 3Duty Cycle202080%See NoteSynchronization Output2060%MAVSYNC OUT = 0.8VSee NotePull Down Current204060%Output connected to SYNC IN of other MQBL unitSee NoteDuty Cycle4060%Current drain required to ensure module is offSee NoteEnable Control (ENA)60% $\mu$ ACurrent drain required to ensure module is offSee NoteOff-State Voltage260% $\mu$ ACurrent drain required to ensure module is offSee NoteOn-State Voltage22 $\psi$ AImax draw from pin allowed with module still onSee NotePull-Up Voltage3.24.04.8VSee Figure A1, 2, 3Output Voltage Trim Range-1010%See Figure E1, 2, 3RELIABILITY CHARACTERISTICS710 <sup>3</sup> Hrs.10 <sup>3</sup> Hrs.10 <sup>3</sup> Hrs.10 <sup>3</sup> Hrs.GB @ Tcase = 70°C19210 <sup>3</sup> Hrs.10 <sup>3</sup> Hrs.10 <sup>3</sup> Hrs.10 <sup>3</sup> Hrs.WEIGHT CHARACTERISTICS555555WEIGHT CHARACTERISTICS55555	Frequency Range	500		700	kHz		
Duty Cycle2080%See NoteSynchronization Output20mAVSYNC OUT = 0.8VSee NotePull Down Current2060%Output connected to SYNC IN of other MQBL unitSee NoteDuty Cycle4060%Output connected to SYNC IN of other MQBL unitSee NoteEnable Control (ENA)0.8V1, 2, 3Off-State Voltage2-V1, 2, 3Module Off Pulldown Current80-VImax draw from pin allowed with module is offSee NoteOn-State Voltage2VV1, 2, 31, 2, 3Module On Pin Leakage Current20µAImax draw from pin allowed with module still onSee NotePull-Up Voltage3.24.04.8VSee Figure A-Output Voltage Trim Range-1010%See Figure E1, 2, 3ReLIABILITY CHARACTERISTICSGB @ Tcase = 70°C254010³ Hrs.10³ HrsMEIGHT CHARACTERISTICS10³ HrsWEIGHT CHARACTERISTICS10³ Hrs				5.5	-		
Synchronization OutputImage							
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	-		192		10 <sup>3</sup> Hrs.		
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Device Weight 35 g g	Device Weight		35		g		

#### **Electrical Characteristics Notes**

1. Converter will undergo input over-voltage shutdown.

2. Derate output power for continuous operation per Figure 5.

3. High or low state of input voltage must persist for about 200µs to be acted on by the shutdown circuitry.

4. Current limit inception is defined as the point where the output voltage has dropped to 90% of its nominal value. See Current Limit discussion in Features Description section.

5. Parameter not tested but guaranteed to the limit specified.

6. Load current transition time  $\geq$  10µs.

7. Line voltage transition time  $\geq$  100µs.

8. Input voltage rise time  $\leq 250 \mu s$ .

9. Operating the converter at a synchronization frequency above the free running frequency will cause the converter's efficiency to be slightly reduced and it may also cause a slight reduction in the maximum output current/power available. For more information consult the factory.

10. After a disable or fault event, module is inhibited from restarting for 100ms. See Shut Down section of the Control Features description. 11. Only the ES and HB grade products are tested at three temperatures. The C grade products are tested at one temperature. Please refer to the Construction and Environmental Stress Screening Options table for details.

12. These derating curves apply for the ES and HB grade products. The C grade product has a maximum case temperature of 70°C.

13. The regulation stage operates to control the positive output. The negative output displays the cross regulation.

14. All +Vout and -Vout voltage measurements are made with Kelvin probes on the output leads.

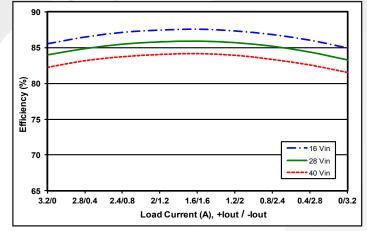
15. The specified operating case temperature for ES grade products is -45°C to 100°C. The specified operating case temperature for C grade products is 0°C to 70°C.

Current: 4A Total

90 85 Efficiency (%) 80 75 16 Vin 70 28 Vin 40 Vin 65 0 5 10 15 20 Total Output Power (W)

**Technical** Figures

**Figure 1**: Efficiency vs. output power, from zero load to full load with equal load on the +5V and -5V outputs at minimum, nominal, and maximum input voltage at Tcase= $25^{\circ}$ C.



**Figure 3**: Efficiency vs. output power, with total output current fixed at 80% load (16W) and loads split as shown between the +5V and -5V outputs at minimum, nominal, and maximum input voltage at Tcase=25°C.

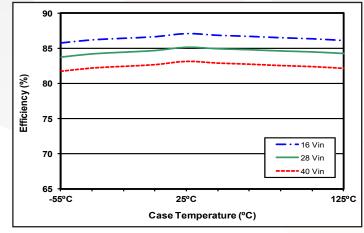
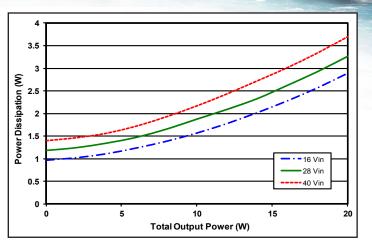
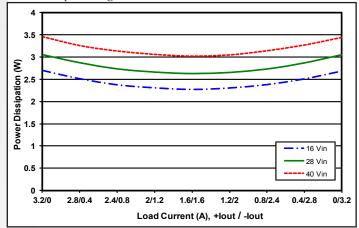


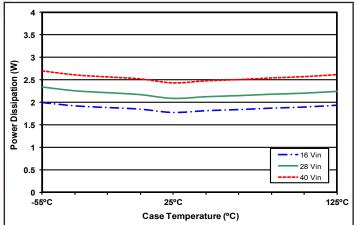
Figure 5: Efficiency at 60% load (1.2A load on +5V and 1.2A load on -5V) versus case temperature for Vin = 16V, 28V and 40V.



**Figure 2**: Power dissipation vs. output power, from zero load to full load with equal load on the +5V and -5V outputs at minimum, nominal, and maximum input voltage at Tcase= $25^{\circ}$ C.



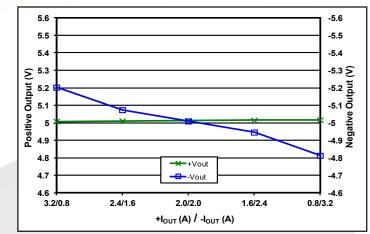
**Figure 4**: Power dissipation vs. output power, with total output current fixed at 80% load (16W) and loads split as shown between the +5V and -5V outputs at minimum, nominal, and maximum input voltage at  $Tcase=25^{\circ}C$ .



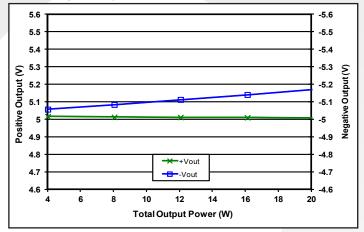
*Figure 6*: Power Dissipation at 60% load (1.2A load on +5V and 1.2A load on -5V) versus case temperature for Vin = 16V, 28V and 40V.

Current: 4A Total

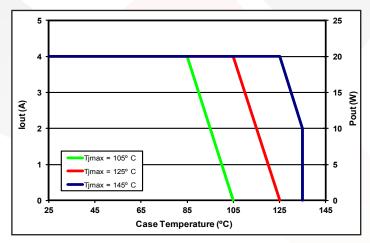
# Technical Figures



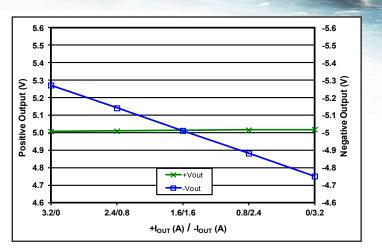
**Figure** 7: Load regulation vs. load current with power fixed at full load (20W) and load currents split as shown between the +5V and -5V outputs, at niminal input voltage and Tcase =  $25^{\circ}$ C.



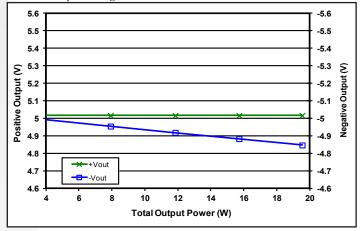
**Figure 9**: Load regulation vs. total output power from zero to full load where +Iout equals three times -Iout a nominal input voltage and Tcase =  $25^{\circ}$ C.



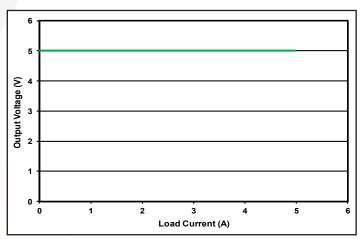
**Figure 11**: Output Current / Output Power derating curve as a function of Tcase and the Maximum desired power MOSFET junction temperature at Vin = 28V (see Note 12).



**Figure 8**: Load regulation vs. load current with power fixed at 80% load (16W) and load currents split as shown between the +5V and -5V outputs, at niminal input voltage and Tcase = 25°C.

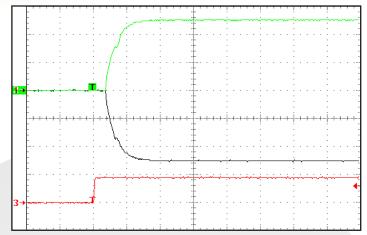


*Figure 10*: Load regulation vs. total output power from zero to full load where -lout equals three times +lout a nominal input voltage and Tcase =  $25^{\circ}$ C.

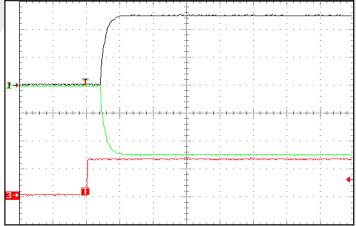


*Figure 12:* Positive output voltage vs. total load current, evenly split, showing typical current limit curves at Vin = 28V.

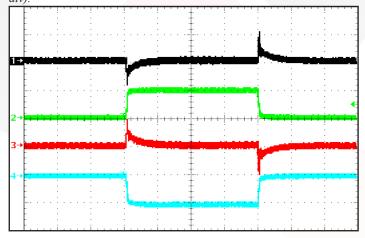




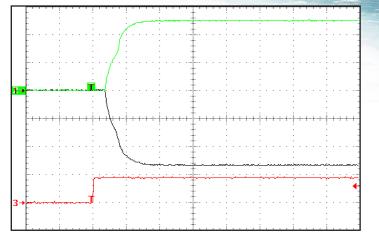
*Figure 13*: Turn-on transient at full load current (resistive load) (5ms/ div). Input voltage pre-applied. Ch 1: +Vout (2V/div); Ch 2: -Vout (2V/ div); Ch 3: Enable1 input (5V/div).



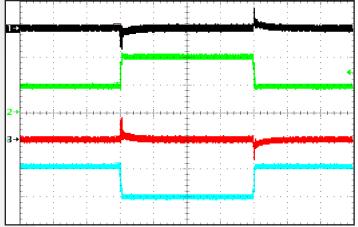
**Figure 15**: Turn-on transient at full load current, after application of input voltage (ENA 1 logic high) (10ms/div). Input voltage pre-applied. Ch 1: +Vout (2V/div); Ch 2: -Vout (2V/div); Ch 3: Enable1 input (20V/div).



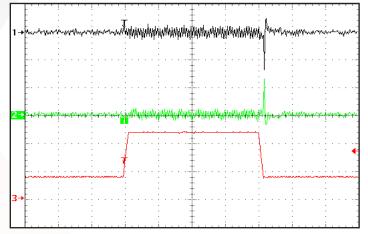
**Figure 17**: Output voltage response to step-change in total load current (0%-50%-0%) of total lout (max) split 50%/50%. Load cap:  $1\mu$ F ceramic cap and  $10\mu$ F,  $100m\Omega$  ESR tantalum cap (1mS/Div). Ch 1: +Vout (200mV/div); Ch 2: +Iout (2A/div); Ch 3: -Vout (200mV/div); Ch 4: -Iout (2A/div).



*Figure 14*: Turn-on transient at zero load current (5ms/div). Input voltage pre-applied. Ch 1: +Vout (2V/div); Ch 2: -Vout (2V/div); Ch 3: Enable1 input (5V/div).



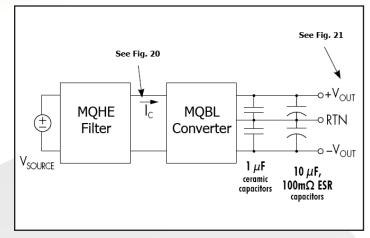
**Figure 16**: Output voltage response to step-change in total load current (50%-100%-50%) of total lout (max) split 50%/50%. Load cap:  $1\mu$ F ceramic cap and  $10\mu$ F,  $100m\Omega$  ESR tantalum cap (1mS/Div). Ch 1: +Vout (200mV/div); Ch 2: +Iout (2A/div); Ch 3: -Vout (200mV/div); Ch 4: -Iout (2A/div).



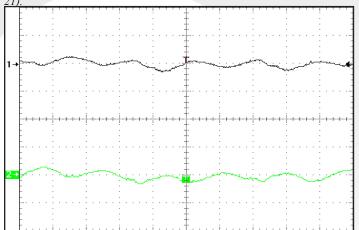
**Figure 18**: Output voltage response to step-change in input voltage (16V-50V-16V). Load cap:  $1\mu$ F ceramic cap and  $10\mu$ F,  $100m\Omega$  ESR tantalum cap (1mS/Div). Ch 1: +Vout (200mV/div); Ch 2: -Vout (200mV/div); Ch 3: Vin (20V/div).

# Technical Figures

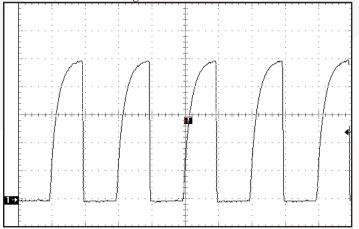
#### MQBL-28-05D Output: ±5V Current: 4A Total



**Figure 19**: Test set-up diagram showing measurement points for Input Terminal Ripple Current (Figure 20) and Output Voltage Ripple (Figure 21)



**Figure 21**: Output voltage ripple, +Vout (Ch 1) and -Vout (Ch 2), at nominal input voltage and full load current evenly split (50mV/div), 1us/Div. Load capacitance: 1µF ceramic cap and 10µF tantalum cap.. Bandwidth; 10MHz. See Figure 19.



*Figure 23*: SYNC OUT vs. time, driving SYNC IN of a second SynQor MQBL converter.

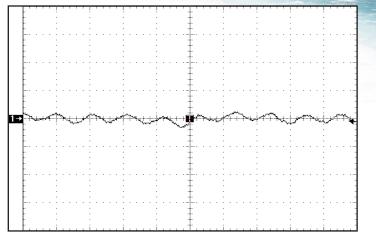
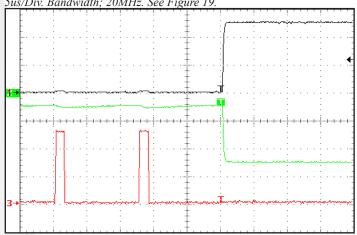
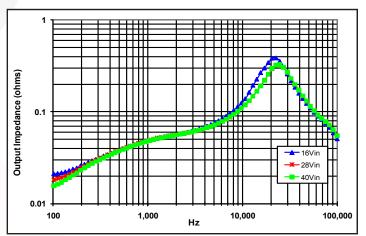


Figure 20: Input terminal current ripple, ic, at full rated output current and nominal input voltage with SynQor MQ filter module (50mA/div), 5us/Div. Bandwidth; 20MHz. See Figure 19.

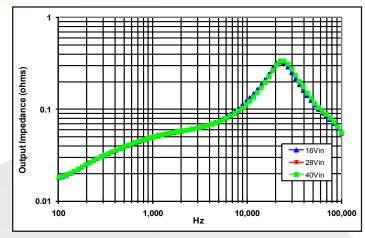


**Figure 22**: Rise of output voltage after the removal of a short across the positive output terminals (50mS/div). Ch l: +Vout (2V/div); Ch 2: -Vout (2V/div); Ch 3:+Iout (2A/div).



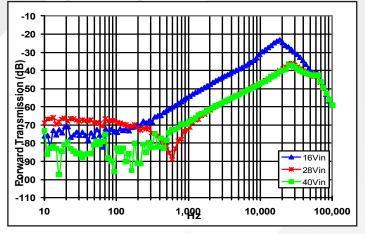
**Figure 24**: Magnitude of incremental output impedance of +5V output (+Zout =+ vout/+iout) for minimum, nominal, and maximum input voltage at full rated power (80/20 split).

Current: 4A Total

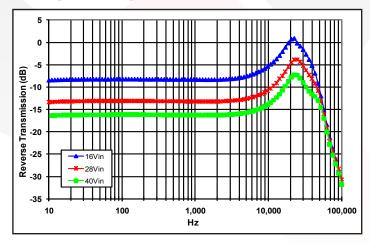


**Technical Figures** 

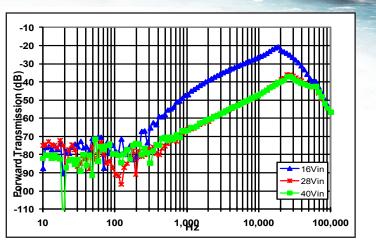
**Figure 25**: Magnitude of incremental output impedance of -5V output (-Zout = -vout/-iout) for minimum, nominal, and maximum input voltage at full rated power (80/20 split)



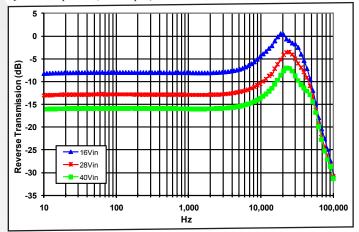
**Figure 27**: Magnitude of incremental forward transmission of -5V output (-FT = -vout/-vin) for minimum, nominal, and maximum input voltage at full rated power (80/20 split)



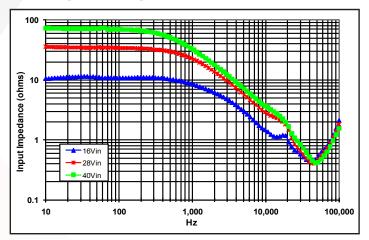
**Figure 29**: Magnitude of incremental reverse transmission of -5V output (-RT = -iin/-iout) for minimum, nominal, and maximum input voltage at full rated power (80/20 split)



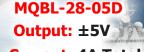
**Figure 26**: Magnitude of incremental forward transmission of +5V output (+FT = +vout/+vin) for minimum, nominal, and maximum input voltage at full rated power (80/20 split)



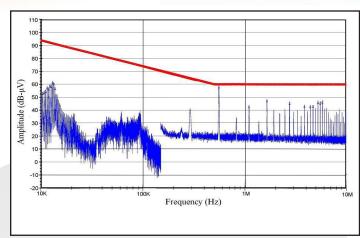
**Figure 28**: Magnitude of incremental reverse transmission of +5V output (+RT = +iin/+iout) for minimum, nominal, and maximum input voltage at full rated power (80/20 split)



**Figure 30**: Magnitude of incremental input impedance (Zin = vin/iin) for minimum, nominal, and maximum input voltage at full rated power (80/20 split)



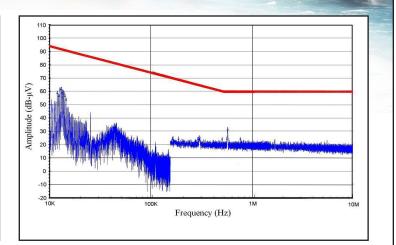
**Current: 4A Total** 



**Technical Figures** 

R

*Figure 31*: High frequency conducted emissions of standalone MQHL-28-05S, 5Vout module at 50W output, as measured with Method CE102. Limit line shown is the 'Basic Curve' for all applications with a 28V



**Figure 32**: High frequency conducted emissions of MQHL-28-05S, 5Vout module at 50W output with MQHE-28-P filter, as measured with Method CE102. Limit line shown is the 'Basic Curve' for all applications with a 28V source.



#### BASIC OPERATION AND FEATURES

The MQBL DC/DC converter uses a two-stage power conversion topology. The first, or regulation, stage is a buck-converter that keeps the output voltage constant over variations in line, load, and temperature. The second, or isolation, stage uses transformers to provide the functions of input/output isolation and voltage transformation to achieve the output voltage required.

In the dual output converter there are two secondary windings in the transformer of the isolation stage, one for each output. There is only one regulation stage, however, and it is used to control the positive output. The negative output therefore displays "Cross-Regulation", meaning that its output voltage depends on how much current is drawn from each output.

Both the positive and the negative outputs share a common OUTPUT RETURN pin.

Both the regulation and the isolation stages switch at a fixed frequency for predictable EMI performance. The isolation stage switches at one half the frequency of the regulation stage, but due to the push-pull nature of this stage it creates a ripple at double its switching frequency. As a result, both the input and the output of the converter have a fundamental ripple frequency of about 550 kHz in the free-running mode.

Rectification of the isolation stage's output is accomplished with synchronous rectifiers. These devices, which are MOSFETs with a very low resistance, dissipate far less energy than would Schottky diodes. This is the primary reason why the MQBL converters have such high efficiency, particularly at low output voltages.

Besides improving efficiency, the synchronous rectifiers permit operation down to zero load current. There is no longer a need for a minimum load, as is typical for converters that use diodes for rectification. The synchronous rectifiers actually permit a negative load current to flow back into the converter's output terminals if the load is a source of short or long term energy. The MQBL converters employ a "backdrive current limit" to keep this negative output terminal current small.

There is a control circuit in the MQBL converter that determines the conduction state of the power switches. It communicates across the isolation barrier through a magnetically coupled device. No opto-isolators are used.

An input under-voltage shutdown feature with hysteresis is provided, as well as an input over-voltage shutdown and an output over-voltage limit. There is also an output current limit that is nearly constant as the load impedance decreases (i.e., there is not fold-back or fold-forward characteristic to the output current under this condition). When a load fault is removed, the output voltage rises exponentially to its nominal value without an overshoot. If a load fault pulls the output voltage below about 60% of nominal, the converter will shut down to attempt to clear the load fault. After a short delay it will try to auto-restart.

The MQBL converter's control circuit does not implement an over-temperature shutdown.

The following sections describe the use and operation of additional control features provided by the MQBL converter.

# CONTROL FEATURES

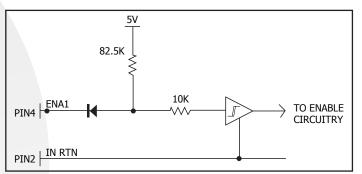


Figure A: Circuit diagram shown for reference only, actual circuit components may differ from values shown for equivalent circuit.

**ENABLE:** The MQBL converter has one enable pin, ENA1 (pin 4), which is referenced with respect to the converter's input return (pin 2). It must have a logic high level for the converter to be enabled; a logic low inhibits the converter.

The enable pin is internally pulled high so that an open connection will enable the converter. Figure A shows the equivalent circuit looking into the enable pin. It is TTL compatible and has hysteresis.

**SHUT DOWN:** The MQBL converter will shut down in response to only five conditions: ENA input low, VIN input below under-voltage shutdown threshold, VIN input above over-voltage shutdown threshold, output voltage below the output under-voltage threshold, and output voltage above the output over-voltage threshold. Following any shutdown event, there is a startup inhibit delay which will prevent the converter from restarting for approximately 100ms. After the 100ms delay elapses, if the enable inputs are high and the input voltage is within the operating range, the converter

will restart. If the VIN input is brought down to nearly 0V and back into the operating range, there is no startup inhibit, and the output voltage will rise according to the "Turn-On Delay, Rising Vin" specification.

oplication Section

**SYNCHRONIZATION:** The MQBL converter's switching frequency can be synchronized to an external frequency source that is in the 500 kHz to 700 kHz range. A pulse train at the desired frequency should be applied to the SYNC IN pin (pin 6) with respect to the INPUT RETURN (pin 2). This pulse train should have a duty cycle in the 20% to 80% range. Its low value should be below 0.8V to be guaranteed to be interpreted as a logic low, and its high value should be above 2.0V to be guaranteed to be interpreted as a logic low. The transition time between the two states should be less than 300ns.

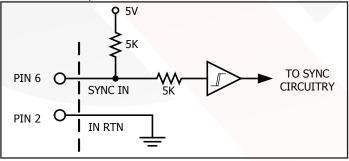
If the MQBL converter is not to be synchronized, the SYNC IN pin should be left open circuit. The converter will then operate in its free-running mode at a frequency of approximately 550 kHz.

If, due to a fault, the SYNC IN pin is held in either a logic low or logic high state continuously, or the SYNC IN frequency is outside the 500-700 kHz range, the MQBL converter will revert to its free-running frequency.

The MQBL converter also has a SYNC OUT pin (pin 5). This output can be used to drive the SYNC IN pins of as many as ten (10) other MQBL converters. The pulse train coming out of SYNC OUT has a duty cycle of 50% and a frequency that matches the switching frequency of the converter with which it is associated. This frequency is either the free-running frequency if there is no valid synchronization signal at the SYNC IN pin, or the synchronization frequency if there is.

The synchronization feature is entirely compatible with that of SynQor's MQFL family of converters.

Figure B shows the equivalent circuit looking into the SYNC IN pin and Figure C shows the equivalent circuit looking into the SYNC OUT pin.



**Figure B:** Equivalent circuit looking into the SYNC IN pin with respect to the IN RTN (input return) pin.

**OUTPUT VOLTAGE TRIM:** If desired, it is possible to increase or decrease the MQBL dual converter's output voltage from its nominal value. To increase the output voltage a resistor, Rtrim up, should be connected between TRIM pin (pin 10) and the OUTPUT RETURN pin (pin 8), as shown in Figure D. The value of this resistor should be determined according to the following equation of from Figure E:

 $Rtrim up(\Omega) = \frac{6000\Omega*Vnom}{Vout - Vnom} - 30000\Omega$ 

where:

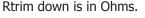
Vnom = the converter's nominal output voltage, Vout = the desired output voltage (greater than Vnom), and Rtrim up is in Ohms.

As the output voltage is trimmed up, it produces a greater voltage stress on the converter's internal components and may cause the converter to fail to deliver the desired output voltage at the low end of the input voltage range at the higher end of the load current and temperature range. Please consult the factory for details. To trim the output voltage below its nominal value, connect an external resistor between the TRIM pin and the POSITIVE OUTPUT pin (pin 7), as shown in Figure D. The value of this trim down resistor should be chosen according to the following equation or from Figure E:

Rtrim down(
$$\Omega$$
) =  $\frac{15100\Omega*Vout - 6000\Omega*Vnom}{Vnom - Vout}$  - 30000 $\Omega$ 

where:

Vnom = the converter's nominal output voltage, Vout = the desired output voltage (less than Vnom), and



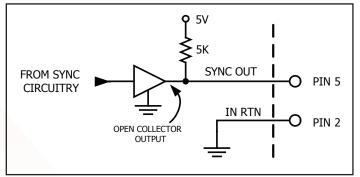


Figure C: Equivalent circuit looking into SYNC OUT pin with respect to the IN RTN (input return) pin.

Current: 4A Total

# **Application Section**

**INPUT UNDER-VOLTAGE SHUTDOWN:** The MQBL converter has an under-voltage shutdown feature that ensures the converter will be off if the input voltage is too low. The input voltage turn-on threshold is higher than the turn-off threshold. In addition, the MQBL converter will not respond to a state of the input voltage unless it has remained in that state for more than about 200µs. This hysteresis and the delay ensure proper operation when the source impedance is high or in a noisy environment.

**INPUT OVER-VOLTAGE SHUTDOWN:** The MQBL converter also has an over-voltage feature that ensures the converter will be off if the input voltage is too high. It also has a hysteresis and time delay to ensure proper operation.

**OUTPUT OVER-VOLTAGE SHUTDOWN:** The MQBL converter will shut down if the voltage at its power output pins ever exceeds about 130% of the nominal value. The shutdown threshold does not change with output trim or sense drops; excessive trim-up or output wiring drops may cause an output over-voltage shutdown event. After a startup inhibit delay, the converter will attempt to restart.

**OUTPUT UNDER-VOLTAGE SHUTDOWN:** The MQBL converter will also shut down if the voltage at its power output pins ever dips below 60% of the nominal value for more than a few milliseconds. Output voltage reduction due to output current overload (current limit) is the most common trigger for this shutdown. The shutdown threshold does not change with output trim but at only 10%, trim-down should not trigger this event. After a startup inhibit delay, the converter will attempt to restart. This shutdown is disabled during startup.

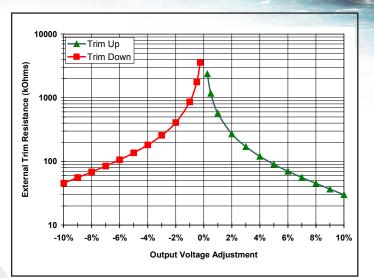
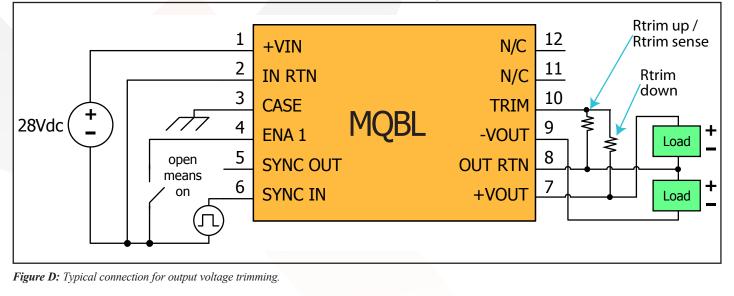


Figure E: Trim up and Trim down as a function of external trim resistance.

**BACK-DRIVE CURRENT LIMIT:** Converters that use MOSFETs as synchronous rectifiers are capable of drawing a negative current from the load if the load is a source of short- or long-term energy. This negative current is referred to as a "back-drive current".

Conditions where back-drive current might occur include paralleled converters that do not employ current sharing. It can also occur when converters having different output voltages are connected together through either explicit or parasitic diodes that, while normally off, become conductive during startup or shutdown. Finally, some loads, such as motors, can return energy to their power rail. Even a load capacitor is a source of back-drive energy for some period of time during a shutdown transient.



To avoid any problems that might arise due to back-drive current, the MQBL converters limit the negative current that the converter can draw from its output terminals. The threshold for this back-drive current limit is placed sufficiently below zero so that the converter may operate properly down to zero load, but its absolute value (see the Electrical Characteristics page) is small compared to the converter's rated output current.

pplication Section

**CURRENT LIMIT:** In the event of excess load, the MQBL converter will quickly reduce its output voltage to keep the load current within safe limits (see Figure 12). If the overload persists for more than 14 milliseconds, the converter will shut off, wait a restart delay, and then automatically attempt to re-start. The timeout is internally implemented with an integrator: counting up whenever current limit is active, and counting down at 1/5th the rate whenever current limit becomes inactive. In this way a series of short-duration overloads will not cause the converter to shut down, while it will shut down in response to sustained overloads.

**THERMAL CONSIDERATIONS:** Figure 11 shows the suggested Power Derating Curves for this converter as a function of the case temperature and the maximum desired power MOSFET junction temperature. All other components within the converter are cooler than its hottest MOSFET, which at full power is no more than 20°C higher than the case temperature directly below this MOSFET.

The Mil-HDBK-1547A component derating guideline calls for a maximum component temperature of 105°C. Figure 11 therefore has one power derating curve that ensures this limit is maintained. It has been SynQor's extensive experience that reliable long-term converter operation can be achieved with a maximum component temperature of 125°C. In extreme cases, a maximum temperature of 145°C is permissible, but not recommended for long-term operation where high reliability is required. Derating curves for these higher temperature limits are also included in Figure 11. The maximum case temperature at which the converter should be operated is 135°C.

When the converter is mounted on a metal plate, the plate will help to make the converter's case bottom a uniform temperature. How well it does so depends on the thickness of the plate and on the thermal conductance of the interface layer (e.g. thermal grease, thermal pad, etc.) between the case and the plate. Unless this is done very well, it is important not to mistake the plate's temperature for the maximum case temperature. It is easy for them to be as much as 5-10°C different at full power and at high temperatures. It is suggested that a thermocouple be attached directly to the converter's case through a small hole in the plate when investigating how hot the converter is getting. Care must also be made to ensure that there is not a large thermal resistance between the thermocouple and the case due to whatever adhesive might be used to hold the thermocouple in place.

**INPUT SYSTEM INSTABILITY:** This condition can occur because any dc-dc converter appears incrementally as a negative resistance load. A detailed application note titled "Input System Instability" is available on the SynQor website which provides an understanding of why this instability arises, and shows the preferred solution for correcting it.



CONSTRUCTION AND ENVIRONMENTAL STRESS SCREENING OPTIONS												
Screening	Consistent with MIL-STD-883F	C-Grade ( specified from 0 °C to +70 °C )	ES-Grade ( specified from (-45 °C to +100 °C )	HB-Grade ( specified from ( -55 °C to +125 °C )								
Element Evaluation		No	Yes	Yes								
Internal Visual	*	Yes	Yes	Yes								
Temperature Cycle	Method 1010	No	Condition B (-55 °C to +125 °C)	Condition C (-65 °C to +150 °C)								
Constant Acceleration	Method 2001 (Y1 Direction)	No	500g	Condition A (5000g)								
Burn-in	Method 1015	24 Hrs @ +125 °C	96 Hrs @ +125 °C	160 Hrs @ +125 °C								
Final Electrical Test	Method 5005 (Group A)	+25 °C	-45, +25, +100 °C	-55, +25, +125 °C								
Mechanical Seal, Thermal, and Coating Process			Full QorSeal	Full QorSeal								
External Visual	2009	*	Yes	Yes								
Construction Process			QorSeal	QorSeal								
* Per IPC-A-610 Class 3												

MilQor<sup>®</sup> Hi-Rel converters and filters are offered in three variations of environmental stress screening options. All ES-Grade and HB-Grade MilQor Hi-Rel converters use SynQor's proprietary QorSeal<sup>®</sup> Hi-Rel assembly process that includes a Parylene-C coating of the circuit, a high performance thermal compound filler, and a nickel barrier gold plated aluminum case. Each successively higher grade has more stringent mechanical and electrical testing, as well as a longer burn-in cycle. The ES- and HB-Grades are also constructed of components that have been procured through an element evaluation process that pre-qualifies each new batch of devices.

Product# MQBL-28-05D

Phone 1-888-567-9<u>596</u>

Doc.# 005-0006202 Rev. E

# Syncor Technical Specifications

MQBL-28-05D Output: ±5V

**Current:** 4A Total Elinest Line

Distant

	MIL-ST	D-810F Qualification Testing						
MIL-STD-810F Test	Method	Description						
Fungus	508.5	Table 508.5-I						
Altitude	500.4 - Procedure I	Storage: 70,000 ft / 2 hr duration						
Aititude	500.4 - Procedure II	Operating: 70,000 ft / 2 hr duration; Ambient Temperature						
Rapid Decompression	500.4 - Procedure III	Storage: 8,000 ft to 40,000 ft						
Acceleration	513.5 - Procedure II	Operating: 15 g						
Salt Fog	509.4	Storage						
	501.4 - Procedure I	Storage: 135°C / 3 hrs						
High Temperature	501.4 - Procedure II	Operating: 100°C / 3 hrs						
· · · · <del>·</del> · · · · · · · · · · · · · ·	502.4 - Procedure I	Storage: -65°C / 4 hrs						
Low Temperature	502.4 - Procedure II	Operating: -55°C / 3 hrs						
Temperature Shock	503.4 - Procedure I - C	Storage: -65°C to 135°C; 12 cycles						
Rain	506.4 - Procedure I	Wind Blown Rain						
Immersion	512.4 - Procedure I	Non-Operating						
Humidity	507.4 - Procedure II	Aggravated cycle @ 95% RH (Figure 507.5-7 aggravated temp - humidity cycle, 15 cycles)						
Random Vibration	514.5 - Procedure I	10 - 2000 Hz, PSD level of 1.5 g <sup>2</sup> /Hz (54.6 grms), duration = 1 hr/axis						
Shock	516.5 - Procedure I	20 g peak, 11 ms, Functional Shock (Operating no load) (saw tooth)						
SHUCK	516.5 - Procedure VI	Bench Handling Shock						
Sinusoidal vibration	514.5 - Category 14	Rotary wing aircraft - helicopter, 4 hrs/axis, 20 g (sine sweep from 10 - 500 Hz)						
	510.4 - Procedure I	Blowing Dust						
Sand and Dust	510.4 - Procedure II	Blowing Sand						

# Support Technical Specifications

MQBL-28-05D Output: ±5V

**Current:** 4A Total

A DEAL

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First Article Testing consistent with MIL-STD-883F									
MIL-STD-883F Test	Method	Description							
Electrical Tests	5005								
Physical Dimensions test	2016								
Resistance to Solvents test	2015.13								
Solderability test	2003.8								
Lead Integrity test	2004.5								
Salt Atmosphere test	1009.8	Condition "A"							
Adhesion of Lead Finish test	2025.4								
Altitude Operation test	1001	Condition "C"							
ESD Sensitivity	3015.7	Class 2							
Stabilization Bake test	1008.2	Condition "C"							
Vibration Fatigue test	2005.2	Condition "A"							
Random Vibration test	2026	Condition "II K"							
Sequential Test Group #1									
Life Test – Steady State test	1005.8								
Life Test – Intermittent Duty test	1006								
Sequential Test Group #2									
Temperature Cycle test	1010.8	Condition "C"							
Constant Acceleration test	2001.2	Condition "A"							
Sequential Test Group #3									
Thermal Shock test	1011.9	Condition "B"							
Temperature Cycle test	1010.8	Condition "C"							
Moisture Resistance test	1004.7	With Sub cycle							
Sequential Test Group #4									
Mechanical Shock test	2002.4	Condition "B"							
Variable Frequency Vibration test	2007.3	Condition "A"							

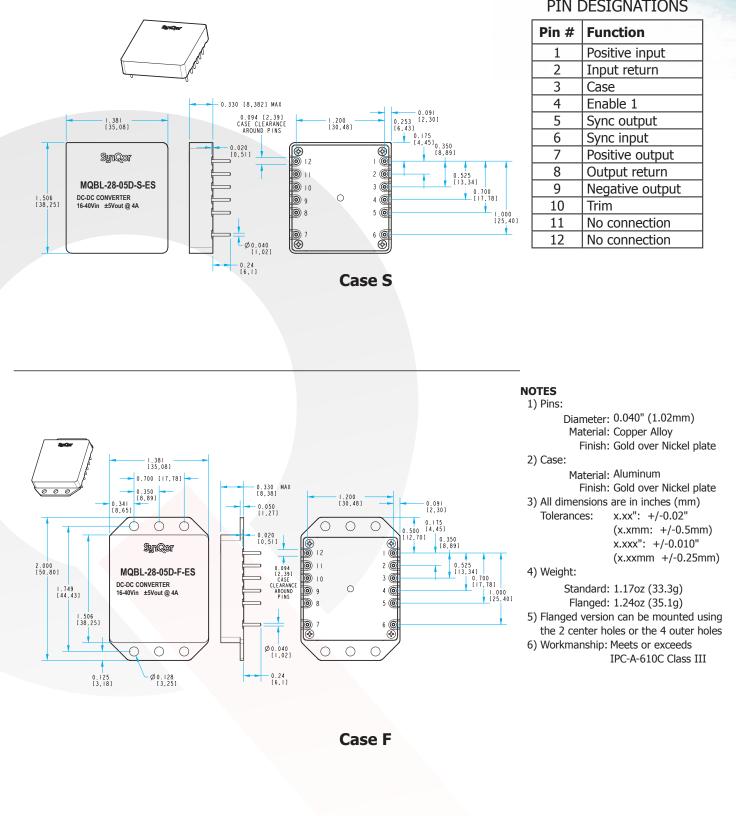
Output: ±5V

**MQBL-28-05D** 

**Current: 4A Total** 

Mechanical Diagrams





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#### **MilQor Converter FAMILY MATRIX**

The tables below show the array of MilQor converters available. When ordering SynQor converters, please ensure that you use the complete part number according to the table in the last page. Contact the factory for other requirements.

					Sing	le Ou	tput						Dua	l Outp	ut †	
	1.5V	1.8V	2.5V	3.3V	5V	6V	7.5V	9V	12V	15V	28V		5V	12V	15V	
	(1R5S)	(1R8S)	(2R5S)	(3R3S)	(05S)	(06S)	(7R5S)	( <b>09</b> S)	(125)	(15S)	(28S)		(05D)	(12D)	(15D)	
MQHL-28																
16-40Vin Cont.	20A	20A	20A	15A	10A	8A	6.64	5 5 A	4.0	2.24	1 0 4		10A	4A	3.3A	
16-50Vin 1s Trans.*	20A	20A	20A	ISA	IUA	ŏА	0.0A	6.6A 5.5A 4A 3.3A 1.8A	1.0A		Total	Total	Total			
Absolute Max Vin = 60V																
MQHL-28E												Γ				
16-70Vin Cont.	20A	0A 20A	20.4	20A	15A	10A	8A	6.6A	5.5A	4A	2.24	3.3A 1.8A		10A	4A	3.3A
16-80Vin 1s Trans.*	20A		20A	15A	IUA	оA	0.0A	5.5A	44	5.5A	1.0A		Total	Total	Total	
Absolute Max Vin =100V																
MQHR-28																
16-40Vin Cont.	10A	10A 10A	10A	7.5A	5A	4A	44		2A	0.0	0.00		5A	2A	1.65A	
16-50Vin 1s Trans.*	TUA	IUA	IUA	7.5A	ЪА	4A	3.3A	2.75A	ZA	1.65A	0.9A		Total	Total	Total	
Absolute Max Vin = 60V																
MQHR-28E	10A											Ī				
16-70Vin Cont.		10A	10A	10A	7.5A	5A	4A	3.3A	2.75A	2A	1.65A	0.9A		5A	2A	1.65A
16-80Vin 1s Trans.*			IUA	IUA	AC.1	AC	4A	3.3A	2.10A	ZA	Aco.1	U.9A		Total	Total	Total
Absolute Max Vin = 100V												L				

	Single Output											Dua	l Outp	ut †
	1.5V	1.8V	2.5V	3.3V	5V	6V	7.5V	9V	12V	15V	28V	5V	12V	15V
	(1R5S)	(1R8S)	(2R5S)	(3R3S)	( <b>05</b> S)	(06S)	(7R5S)	( <b>09S</b> )	(125)	(15S)	(28S)	(05D)	(12D)	(15D)
MQBL-28														
16-40Vin Cont.	8A	8A	8A	6A	4A	3.3A	2.6A	2.2A	1.6A	1.3A	0.7A	4A	1.6A	1.3A
16-50Vin 1s Trans.*												Total	Total	Total
Absolute Max Vin = 60V														
MQBL-28E														
16-70Vin Cont.	8A	8A	8A	6A	4A	3.3A	2.6A	2.2A	1.6A	1.3A	0.7A	4A	1.6A	1.3A
16-80Vin 1s Trans.*		ÖA	ΰA	UA	4A	5.5A	2.0A	2.2A	1.0A	1.3A	0.7A	Total	Total	Total
Absolute Max Vin =100V														

Check with factory for availability. †80% of total output current available on any one output. \*Converters may be operated at the highest transient input voltage, but some component electrical and thermal stresses would be beyond MIL-HDBK-1547A guidelines.



#### PART NUMBERING SYSTEM

The part numbering system for SynQor's MilQor DC-DC converters follows the format shown in the table below.

Not all combinations make valid part numbers, please contact SynQor for availability. See the Product Summary web page for more options.

Model	lodel Input Voltage(s) Jame Range Output Voltage(s) June Range Output Output		Package Outline/	Screening	
Name			Pin Configuration	Grade	
MQBL	28 28E	1R5S 1R8S 2R5S 3R3S 05S 06S 7R5S 09S 12S 15S 28S	05D 12D 15D	S F	C ES HB

Example: MQBL-28-05D-F-ES

#### **APPLICATION NOTES**

A variety of application notes and technical white papers can be downloaded in pdf format from the SynQor website.

#### Contact SynQor for further information and to order:

Phone:	978-849-0600
Toll Free:	1-888-567-9596
Fax:	978-849-0602
<u>E-mail</u> :	mqnbofae@synqor.com
<u>Web</u> :	www.synqor.com
Address:	155 Swanson Road
	Boxborough, MA 01719
	USA

#### PATENTS

SynQor holds numerous U.S. patents, one or more of which apply to most of its power converter products. Any that apply to the product(s) listed in this document are identified by markings on the product(s) or on internal components of the product(s) in accordance with U.S. patent laws. SynQor's patents include the following:

5,999,417	6,222,742	6,545,890	6,594,159	6,731,520	6,894,468
6,896,526	6,927,987	7,050,309	7,072,190	7,085,146	7,119,524
7,269,034	7,272,021	7,272,023	7,558,083	7,564,702	7,765,687
7,787,261	8,023,290	8,149,597	8,493,751	8,644,027	9,143,042

#### Warranty

SynQor offers a two (2) year limited warranty. Complete warranty information is listed on our website or is available upon request from SynQor.